10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001



Features

- Omni directional radiation (Azimuthal plane)
- Low profile
- Compact size W x L x H (10 x 3.2 x 4 mm)
- Low weight (600 mg)
- Lead free materials
- Fully SMD compatible
- Lead free soldering compatible
- Tape and reel packing
- RoHS compliant product

Applications

- Bluetooth
- 2.4 GHz WLAN
- 2.4 GHz ISM Band System

Electrical specifications @ +25 °C

Note: Electrical characteristics depend on test board (GP) size and antenna positioning on GP and Ground Clearance area size.

WiFi 2.4 GHz

Typical performance

(Test board size 80 x 37 mm, PWB top surface ground removal area 10.80 x 6.25 mm, position 1 on PWB)

Frequency Range	Max Gain	Efficiency	Return loss	Impedance	Operating
[MHz]	[dBi]	[%] / [dB]	min. [dB]	[Ω]	Temperature [° C]
2400 – 2483.5	1.5 (Peak) 0.5 (Band edges)	75 /-1.25 (Peak) 60/-2.25 (Band edges)	-6	50	-45 to +85

Takatie 6



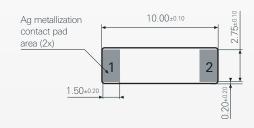
10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001

Terminal Configuration and Dimensions

On Ground type, Top surface ground removal area 10.80 x 6.25 mm

Antenna features

No.	Terminal name	Terminal Dimensions
1	Feed / GND	1.5 x 2.75 mm
2	Feed / GND	1.5 x 2.75 mm



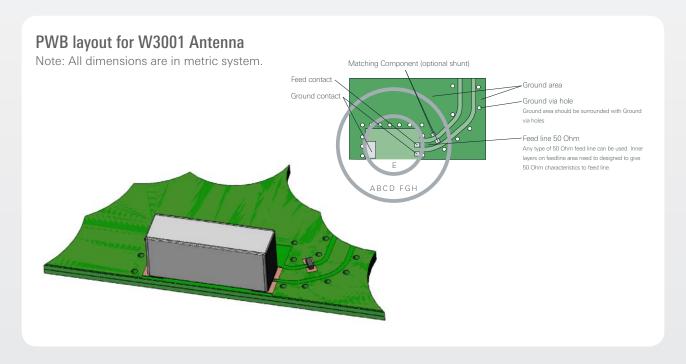
Antenna is symmetrical.

Either of terminals 1 or 2 can be feed / GND

Antenna PWB Layout Specifications

On Ground type, Top surface ground removal area 10.80 x 6.25 mm

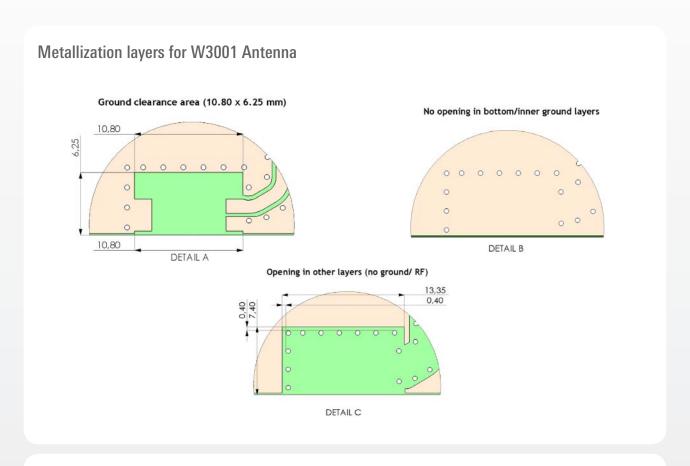
Matching and tuning component values depend on application and surrounding mechanics / materials. Feed line should be designed to match $50~\Omega$ characteristic impedance, depending on PWB material and thickness. Recommended test board layout for electrical characteristic measurement, test board outline size 80~x~37~mm.



Takatie 6



 $10 \times 3.2 \times 4.0$ mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80×6.25 mm). Pulse Part Number: W3001



PWB pad dimensions and antenna position for W3001 Antenna Antenna position on PWB layout 1,30 0,20 0,20 Antenna pads DETAIL E are marked blue

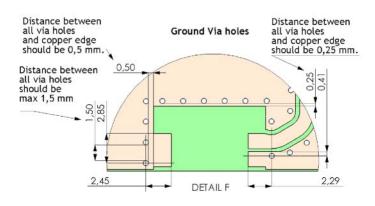
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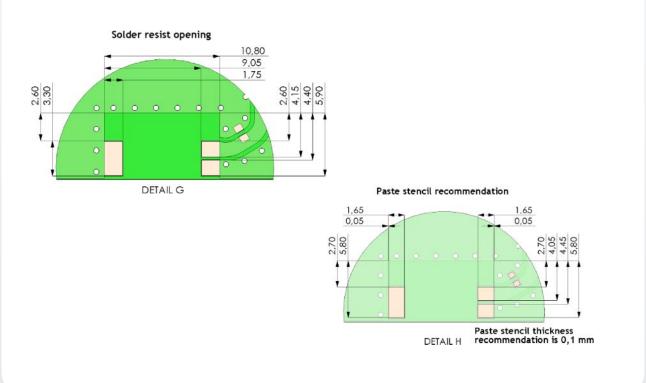


10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001

Typical ground via hole placement in PWB layout for W3001 Antenna



Solder resist opening and Paste stencil recommendation for W3001 Antenna



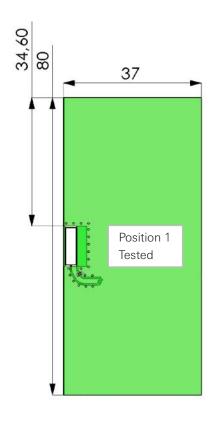
Takatie 6

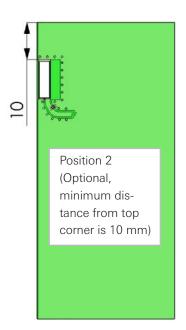


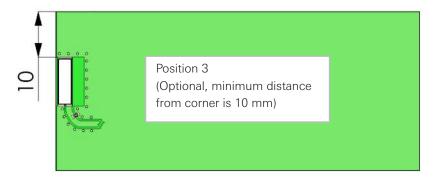
 $10 \times 3.2 \times 4.0 \text{ mm}$ Ceramic Chip Antenna (On Ground type, Top surface ground removal area $10.80 \times 6.25 \text{ mm}$). Pulse Part Number: W3001

Recommended antenna position on PWB for W3001 Antenna

Our test PWB size is 37 x 80 mm, other sized boards can be used depending on customer device size (minimum 35 x 35 mm).







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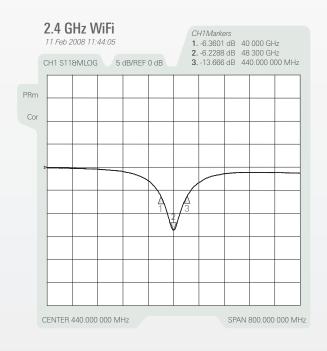
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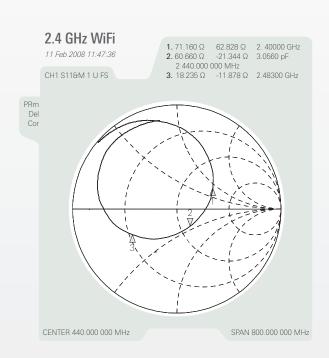


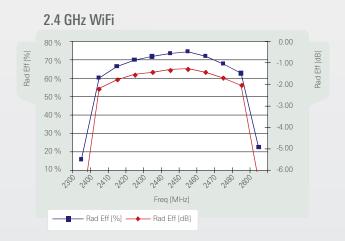
10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001

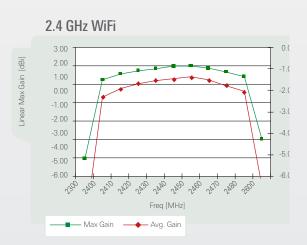
Typical Electrical Characteristics (T=25 °C)

Measured on the 80 x 37 mm test board with matching circuit (1.2 pF shunt matching capacitor on feed). Measured in antenna position 1 on PWB layout, see previous page.







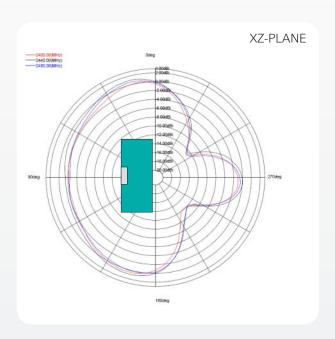


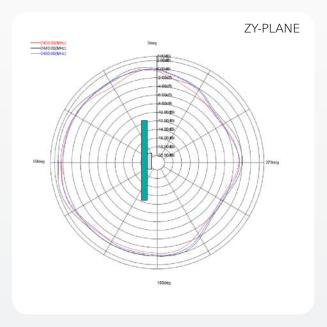
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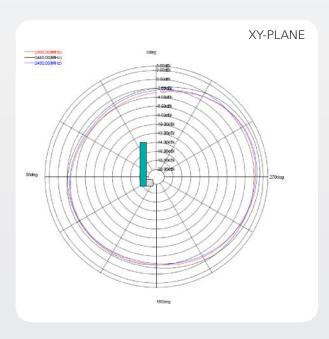


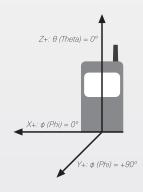
 $10 \times 3.2 \times 4.0 \text{ mm}$ Ceramic Chip Antenna (On Ground type, Top surface ground removal area $10.80 \times 6.25 \text{ mm}$). Pulse Part Number: W3001

Typical Free Space Radiation Patterns









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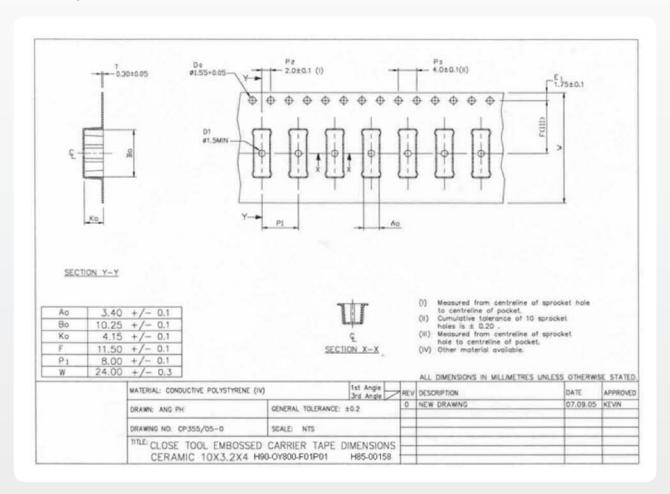


 $10 \times 3.2 \times 4.0$ mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80×6.25 mm). Pulse Part Number: W3001

Packing

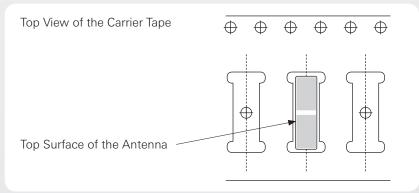
Tape and reel packing is used. Carrier tape, reel and box dimensions are presented in following pictures.

Carrier Tape



Block Orientation

Antenna soldering pads facing down to the bottom of the carrier tape.

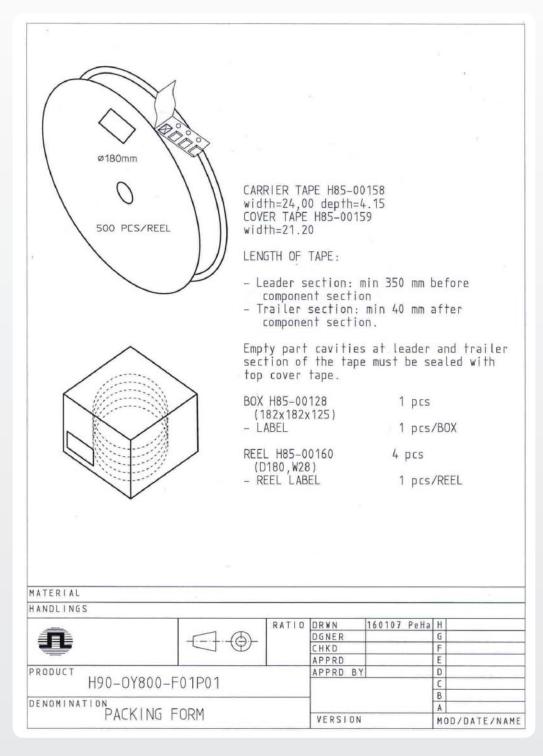


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 $10 \times 3.2 \times 4.0 \text{ mm}$ Ceramic Chip Antenna (On Ground type, Top surface ground removal area $10.80 \times 6.25 \text{ mm}$). Pulse Part Number: W3001

Packing Form

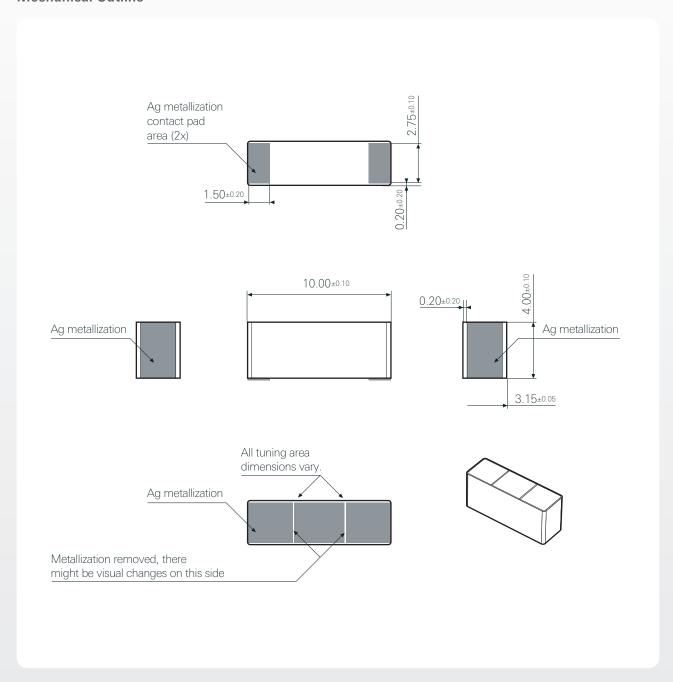


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 $10 \times 3.2 \times 4.0 \text{ mm}$ Ceramic Chip Antenna (On Ground type, Top surface ground removal area $10.80 \times 6.25 \text{ mm}$). Pulse Part Number: W3001

Mechanical Outline



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单击下面可查看定价,库存,交付和生命周期等信息

>>Pulse(普思)